

PS2761B-1

4-PIN SOP PHOTOCOUPLER OPERATING AMBIENT TEMPERATURE 110 °C

R08DS0106EJ0500 Rev.5.00 Jul. 05, 2024

DESCRIPTION

The PS2761B-1 is an optically coupled isolator containing a GaAs light emitting diode and an NPN silicon phototransistor.

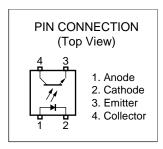
This package is mounted in a plastic SOP (Small Outline Package) for high density applications. The package has shield effect to cut off ambient light.

FEATURES

- Operating ambient temperature: 110 °C
- Isolation distance (0.4 mm MIN.)
- High isolation voltage (BV = 3 750 Vr.m.s.)
- SOP (Small Outline Package) type
- High-speed switching ($t_r = 4 \ \mu s \ TYP$., $t_f = 5 \ \mu s \ TYP$.)
- Embossed tape product : PS2761B-1-F3: 3 500 pcs/reel
- Pb-free product
- Safety standards
 - UL approved: UL1577, Double protection
 - CSA approved: CAN/CSA-C22.2 No. 62368-1, Reinforced insulation
 - BSI approved: BS EN IEC 62368-1, Reinforced insulation
 - SEMKO approved: EN 62368-1, IEC 62368-1, Reinforced insulation
 - NEMKO approved: EN 62368-1, Reinforced insulation
 - FIMKO approved: EN 62368-1, Reinforced insulation
 - DEMKO approved: EN 62368-1, Reinforced insulation
 - CQC approved: GB4943.1-2022, Reinforced insulation
 - VDE approved: DIN EN IEC 60747-5-5 (Option)

APPLICATIONS

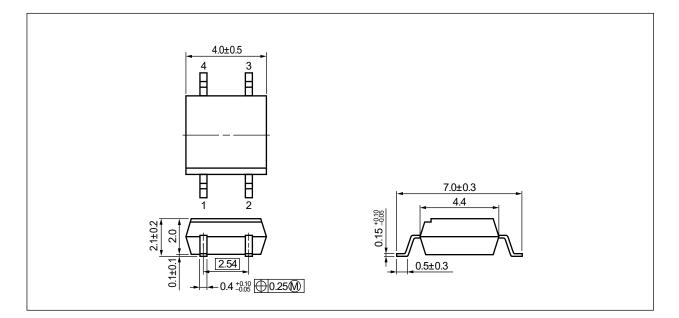
- Power supply
- Hybrid IC
- Programmable logic controllers





Data Sheet

PACKAGE DIMENSIONS (UNIT: mm)

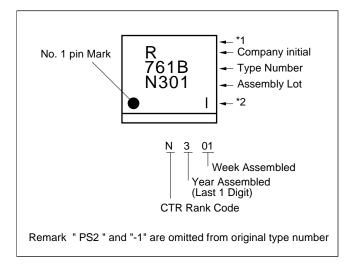


Weight: 0.08 g (TYP.)

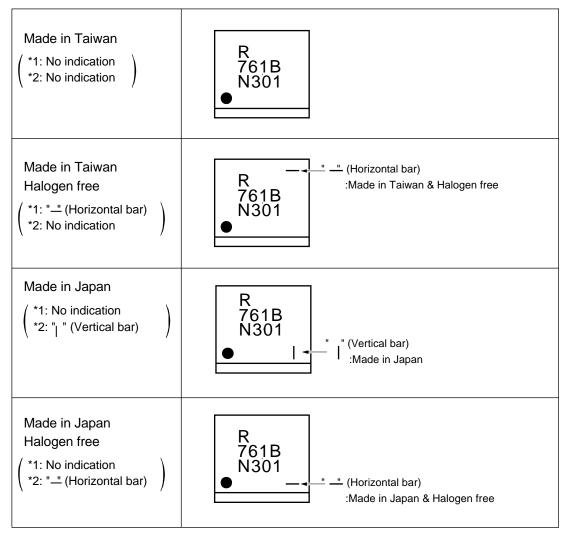
PHOTOCOUPLER CONSTRUCTION

Parameter	MIN.
Air Distance	5 mm
Creepage Distance	5 mm
Isolation Distance 0.4 mm	

MARKING EXAMPLE



Note: Bar indication contents of *1 and *2.



ORDERING INFORMATION

Part Number	Order Number *1	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number *2
PS2761B-1	PS2761B-1-A	Pb-Free	Embossed Tape 20 pcs	UL, CSA, BSI, SEMKO, NEMKO,	PS2761B-1
PS2761B-1-F3	PS2761B-1-F3-A		Embossed Tape 3 500 pcs/reel	FIMKO, DEMKO, CQC Approved	
PS2761B-1-V	PS2761B-1-V-A		Embossed Tape 20 pcs	UL, CSA, BSI, SEMKO, NEMKO,	
PS2761B-1-V-F3	PS2761B-1-V-F3-A		Embossed Tape 3 500 pcs/reel	FIMKO, DEMKO, CQC, VDE Approved	
PS2761B-1	PS2761B-1Y-A	Special version (Pb-Free and	Embossed Tape 20 pcs	UL, CSA, BSI, SEMKO, NEMKO,	PS2761B-1
PS2761B-1-F3	PS2761B-1Y-F3-A	Halogen Free)	Embossed Tape 3 500 pcs/reel	FIMKO, DEMKO, CQC Approved	
PS2761B-1-V	PS2761B-1Y-V-A		Embossed Tape 20 pcs	UL, CSA, BSI, SEMKO, NEMKO,	
PS2761B-1-V-F3	PS2761B-1Y-V-F3-A		Embossed Tape 3 500 pcs/reel	FIMKO, DEMKO, CQC, VDE Approved	

Notes: *1. When specifying CTR rank, please add "/CTR rank" after Order Number.

ex. L rank : PS2761B-1Y-F3-A/L

Notes: *2. For the application of the safety standard, the following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit	
Diode	Forward Current (DC)	IF	50	mA	
	Reverse Voltage	VR	6	V	
	Power Dissipation Derating	∆P _D /°C	0.8	mW/°C	
	Power Dissipation	PD	80	mW	
	Peak Forward Current *1	IFP	1.0	А	
Transistor	Collector to Emitter Voltage	VCEO	70	V	
	Emitter to Collector Voltage	VECO	5	V	
	Collector Current	lc	50	mA	
	Power Dissipation Derating	∆Pc/°C	1.5	mW/°C	
	Power Dissipation	Pc	150	mW	
Isolation Voltage *2		BV	3 750	Vr.m.s.	
Operating Ambient Temperature		TA	–55 to +110	°C	
Storage Temperature		T _{stg}	–55 to +150	°C	

Note: *1. PW = 100 µs, Duty Cycle = 1 %

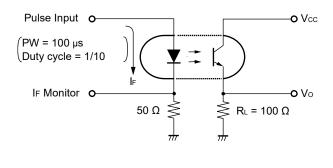
*2. AC voltage for 1 minute at T_A = 25 °C, RH = 60 % between input and output. Pins 1-2 shorted together, 3-4 shorted together.

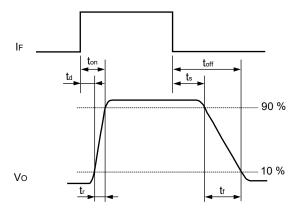
	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	I _F = 5 mA		1.1	1.4	V
	Reverse Current	IR	V _R = 5 V			5	μΑ
	Terminal Capacitance	Ct	V = 0 V, f = 1 MHz		15		pF
Transistor	Collector to Emitter Dark Current	I _{CEO}	I _F = 0 mA, V _{CE} = 24 V			100	nA
Coupled	Current Transfer	CTR	I _F = 5 mA, V _{CE} = 5 V	50	100	400	%
	Ratio (I _C /I _F) ^{*1}	UIK	I _F = 1 mA, V _{CE} = 5 V	10	50		
	Collector Saturation Voltage	V _{CE (sat)}	I _F = 10 mA, I _C = 2 mA			0.3	V
	Isolation Resistance	R _{I-0}	V _{I-O} = 1 kV _{DC}	10 ¹¹			Ω
	Isolation Capacitance	CI-O	V = 0 V, f = 1 MHz		0.4		pF
	Rise Time *2	tr			4		
	Fall Time *2	t _f			5		μs
	Turn-on Time *2	t _{on}	$V_{CC} = 5 V$, $I_C = 2 mA$, $R_L = 100 \Omega$		8		
	Turn-off Time *2	t _{off}			5		

Note: *1. CTR rank

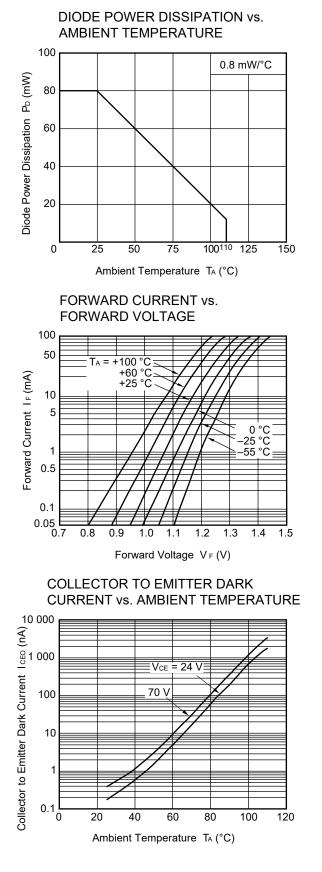
CTR rank	CTR (%)	Conditions
К	200 to 400	I_F = 5 mA, V_{CE} = 5 V
	40 and larger	I_F = 1 mA, V_{CE} = 5 V
L	100 to 300	I_F = 5 mA, V_{CE} = 5 V
	20 and larger	I_F = 1 mA, V_{CE} = 5 V
М	50 to 150	I_F = 5 mA, V_{CE} = 5 V
	10 and larger	I _F = 1 mA, V _{CE} = 5 V
N	50 to 400	I_F = 5 mA, V_{CE} = 5 V
	10 and larger	I _F = 1 mA, V _{CE} = 5 V

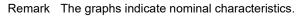
*2. Test Circuit for Switching Time



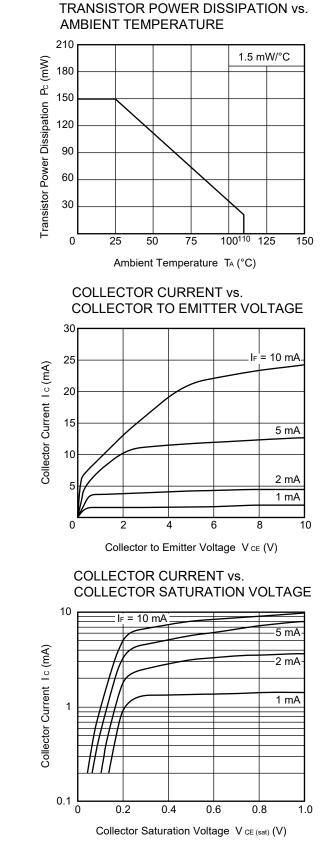


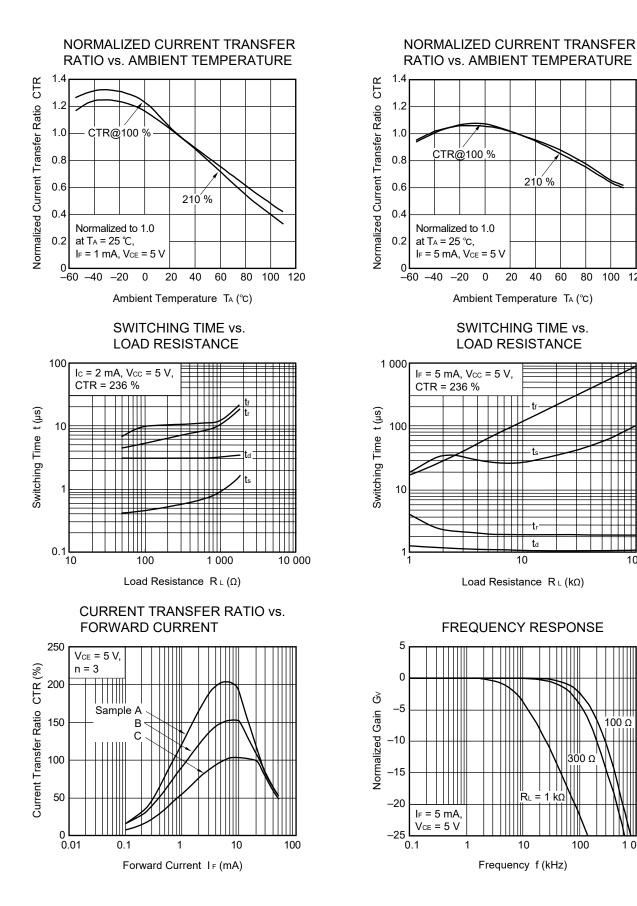
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise specified)





RENESAS







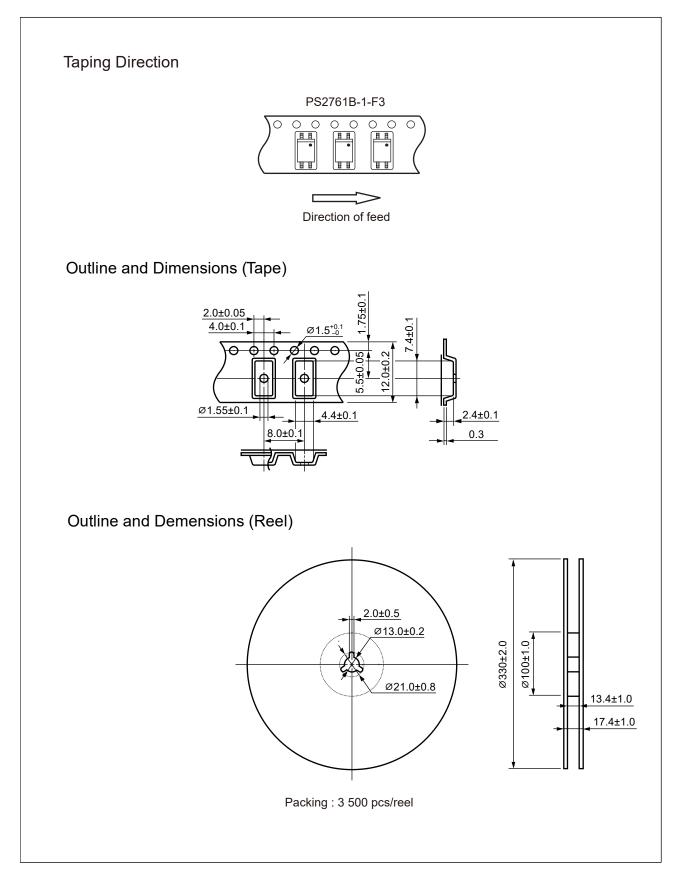
1 000

100 120

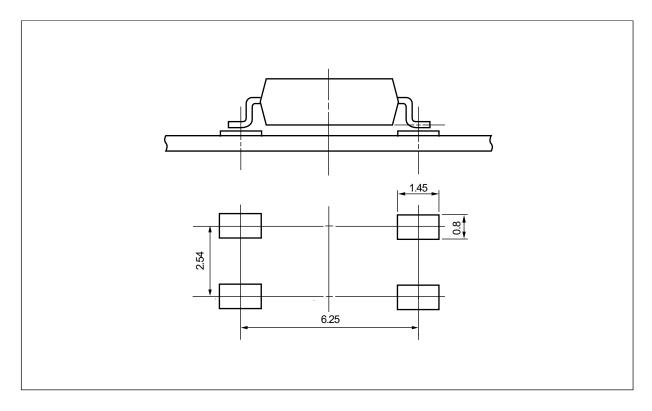
100

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TAPING SPECIFICATIONS (UNIT: mm)



RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



Remark All dimensions in this figure must be evaluated before use.

NOTES ON HANDLING

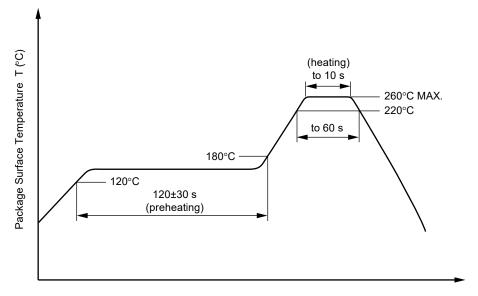
1. Recommended soldering conditions

- (1) Infrared reflow soldering
 - Peak reflow temperature
 - · Time of peak reflow temperature
 - Time of temperature higher than 220 °C
 - Time to preheat temperature from 120 to 180 °C 120 ±30 s
 - Number of reflows
 - Flux

10 seconds or less 60 seconds or less Three Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

260 °C or below (package surface temperature)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

Temperature 260 °C or below (molten solder temperature)

- Time 10 seconds or less
- Preheating conditions 120 °C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

- 350 °C or below • Peak temperature (lead part temperature) Time (per one side)
 - 3 s or less
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Place 1.5 to 2.0 mm or more away from the root of the lead

(4) Cautions

- Flux cleaning Avoid cleaning with Freon- or halogen-based (chlorinated etc.) solvents.
- Fixing/Coating Do not use fixing agents or coatings containing halogen-based substances

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2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

3. Measurement conditions of current transfer ratios (CTR), which differ according to photocoupler Check the setting values before use, since the forward current conditions at CTR measurement differ according to product.

When using products other than at the specified forward current, the characteristics curves may differ from the standard curves due to CTR value variations or the like. Therefore, check the characteristics under the actual operating conditions and thoroughly take variations or the like into consideration before use.

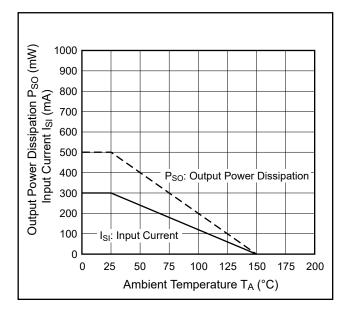
USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

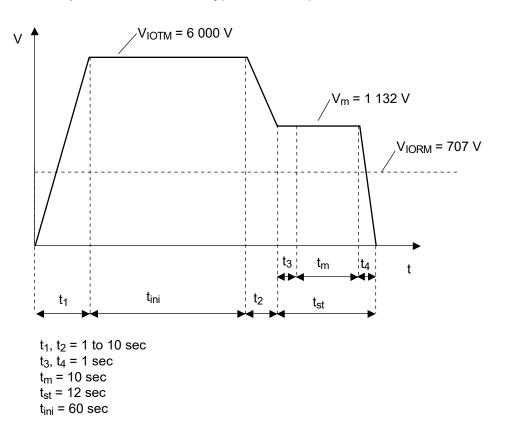
SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Rating	Unit
Climatic test class (IEC 60068-1/DIN EN 60068-1)		55/110/21	
Dielectric strength			
maximum operating isolation voltage	VIORM	707	V _{peak}
Test voltage (partial discharge test, procedure a for type test and random	Vm	1 132	V_{peak}
test)			
V_m = 1.6 × $V_{IORM.}$, q_{pd} < 5 pC			
Test voltage (partial discharge test, procedure b for all devices)	Vm	1 326	Vpeak
V_m = 1.875 × $V_{IORM.}$, q_{pd} < 5 pC	v m	1 520	v реак
Highest permissible overvoltage	VIOTM	6 000	V_{peak}
Degree of pollution (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))		2	
Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303-11))	СТІ	175	
Material group (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))		III a	
Storage temperature range	T _{stg}	-55 to +150	°C
Operating temperature range	TA	-55 to +110	°C
Isolation resistance, minimum value			
V _{I-O} = 500 V dc, T _A = 25 °C	RI-0 MIN.	10 ¹²	Ω
V_{I-O} = 500 V dc, T _A = maximum temperature of rating, at least 100 °C	R⊦o MIN.	10 ¹¹	Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal			
derating curve)			
Maximum ambient temperature	Ts	150	°C
Maximum input current	lsı	300	mA
Maximum output power dissipation	Pso	500	mW
Isolation resistance, minimum value at V_{I-O} = 500 V dc, T_A = T_S	RI-0 MIN.	10 ⁹	Ω

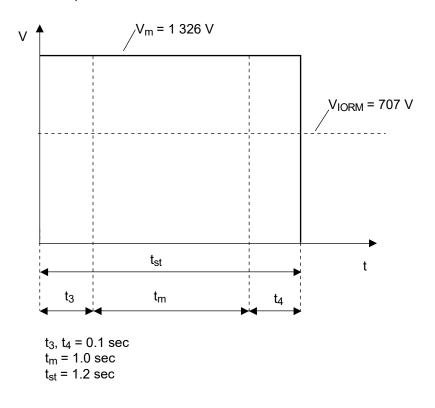
Dependence of maximum safety ratings with package temperature



Method a) Destructive Test, Type and Sample Test



Method b) Non-destructive Test, 100% Production Test



Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	 Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
	2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
	Do not burn, destroy, cut, crush, or chemically dissolve the product.
	• Do not lick the product or i any way allow it to enter the mouth.

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